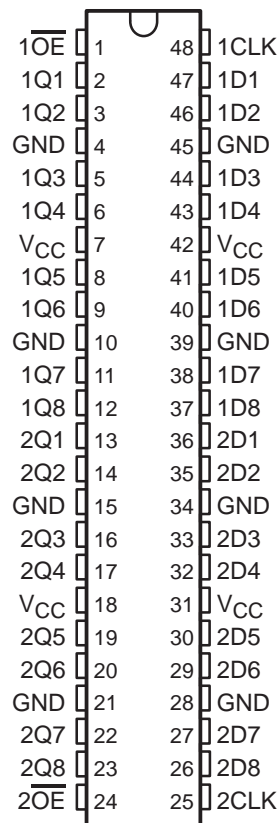


SN54AHC16374, SN74AHC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCLS330G – MARCH 1996 – REVISED JANUARY 2000

- **Members of the Texas Instruments Widebus™ Family**
- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V V_{CC}**
- **3-State Outputs Drive Bus Lines Directly**
- **Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

SN54AHC16374 . . . WD PACKAGE
SN74AHC16374 . . . DGG, DGV, OR DL PACKAGE
(TOP VIEW)



description

The 'AHC16374 devices are 16-bit edge-triggered D-type flip-flops with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

These devices can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

\overline{OE} does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AHC16374 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC16374 is characterized for operation from -40°C to 85°C .



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**TEXAS
INSTRUMENTS**

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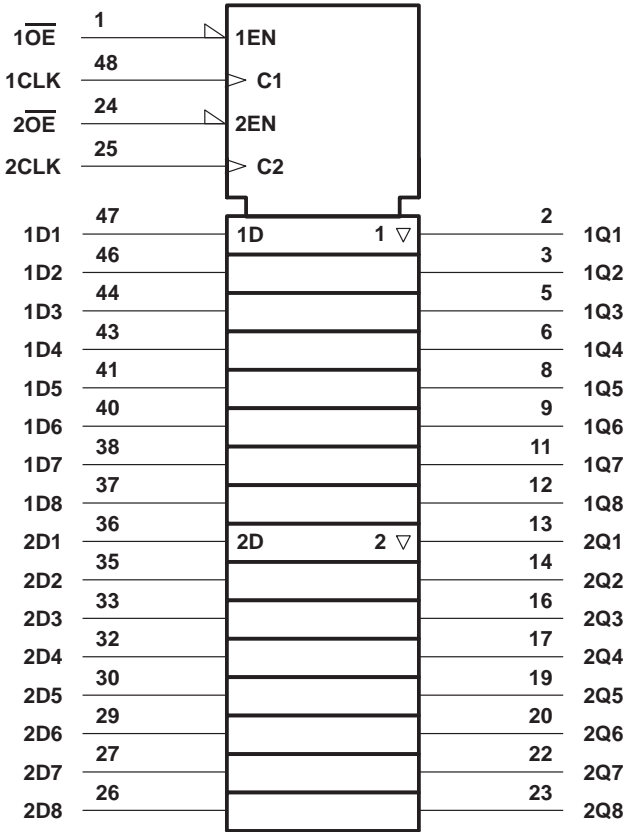
SN54AHC16374, SN74AHC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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FUNCTION TABLE
(each 8-bit flip-flop)

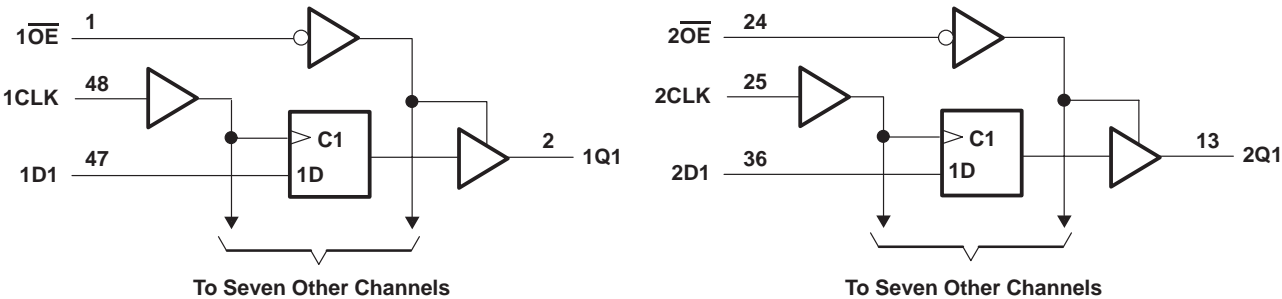
| INPUTS | | | OUTPUT Q |
|-----------------|--------|---|-------------|
| \overline{OE} | CLK | D | |
| L | ↑ | H | H |
| L | ↑ | L | L |
| L | H or L | X | Q_0 |
| H | X | X | Z |

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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| | |
|--|----------------------------|
| Supply voltage range, V_{CC} | −0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | −0.5 V to 7 V |
| Output voltage range, V_O (see Note 1) | −0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | −20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through each V_{CC} or GND | ±75 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DGG package | 70°C/W |
| DGV package | 58°C/W |
| DL package | 63°C/W |

NOTES:

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51.

| | | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-----------------|------------------------------------|---------------------------------|--------------|-----------------|--------------|-----------------|------|
| | | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | | 2 | 5.5 | 2 | 5.5 | V |
| V _{IH} | High-level input voltage | V _{CC} = 2 V | 1.5 | | 1.5 | | V |
| | | V _{CC} = 3 V | 2.1 | | 2.1 | | |
| | | V _{CC} = 5.5 V | 3.85 | | 3.85 | | |
| V _{IL} | Low-level input voltage | V _{CC} = 2 V | | 0.5 | | 0.5 | V |
| | | V _{CC} = 3 V | | 0.9 | | 0.9 | |
| | | V _{CC} = 5.5 V | | 1.65 | | 1.65 | |
| V _I | Input voltage | | 0 | 5.5 | 0 | 5.5 | V |
| V _O | Output voltage | | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | V _{CC} = 2 V | | −50 | | −50 | μA |
| | | V _{CC} = 3.3 V ± 0.3 V | | −4 | | −4 | mA |
| | | V _{CC} = 5 V ± 0.5 V | | −8 | | −8 | |
| I _{OL} | Low-level output current | V _{CC} = 2 V | | 50 | | 50 | μA |
| | | V _{CC} = 3.3 V ± 0.3 V | | 4 | | 4 | mA |
| | | V _{CC} = 5 V ± 0.5 V | | 8 | | 8 | |
| Δt/Δv | Input transition rise or fall rate | V _{CC} = 3.3 V ± 0.3 V | | 100 | | 100 | ns/V |
| | | V _{CC} = 5 V ± 0.5 V | | 20 | | 20 | |
| T _A | Operating free-air temperature | | −55 | 125 | −40 | 85 | °C |



SN54AHC16374, SN74AHC16374

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-----------------|---|-----------------|-----------------------|-----|-------|--------------|------|--------------|------|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | I _{OH} = -50 µA | 2 V | 1.9 | 2 | | 1.9 | | 1.9 | | V |
| | | 3 V | 2.9 | 3 | | 2.9 | | 2.9 | | |
| | | 4.5 V | 4.4 | 4.5 | | 4.4 | | 4.4 | | |
| | I _{OH} = -4 mA | 3 V | 2.58 | | | 2.48 | | 2.48 | | |
| | I _{OH} = -8 mA | 4.5 V | 3.94 | | | 3.8 | | 3.8 | | |
| V _{OL} | I _{OL} = 50 µA | 2 V | | | 0.1 | | 0.1 | | 0.1 | V |
| | | 3 V | | | 0.1 | | 0.1 | | 0.1 | |
| | | 4.5 V | | | 0.1 | | 0.1 | | 0.1 | |
| | I _{OL} = 4 mA | 3 V | | | 0.36 | | 0.5 | | 0.44 | |
| | I _{OL} = 8 mA | 4.5 V | | | 0.36 | | 0.5 | | 0.44 | |
| I _I | V _I = V _{CC} or GND | 0 V to 5.5 V | | | ±0.1 | | ±1* | | ±1 | µA |
| I _{OZ} | V _O = V _{CC} or GND | 5.5 V | | | ±0.25 | | ±2.5 | | ±2.5 | µA |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | 4 | | 40 | | 40 | µA |
| C _i | V _I = V _{CC} or GND | 5 V | | 2.5 | 10 | | | | 10 | pF |
| C _o | V _O = V _{CC} or GND | 5 V | | 3.5 | | | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

**timing requirements over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)**

| | | T _A = 25°C | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-----------------|---------------------------------|-----------------------|-----|--------------|-----|--------------|-----|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _w | Pulse duration, CLK high or low | 5 | | 5.5 | | 5.5 | | ns |
| t _{su} | Setup time, data before CLK↑ | 4.5 | | 4 | | 4 | | ns |
| t _h | Hold time, data after CLK↑ | 2 | | 2 | | 2 | | ns |

**timing requirements over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)**

| | | T _A = 25°C | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-----------------|---------------------------------|-----------------------|-----|--------------|-----|--------------|-----|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _w | Pulse duration, CLK high or low | 5 | | 5 | | 5 | | ns |
| t _{su} | Setup time, data before CLK↑ | 3 | | 3 | | 3 | | ns |
| t _h | Hold time, data after CLK↑ | 2 | | 2 | | 2 | | ns |

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SN54AHC16374, SN74AHC16374

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $T_A = 25^\circ\text{C}$ | | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-------------|-----------------|----------------|----------------------|--------------------------|------|-------|--------------|------|--------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f_{\max} | | | $C_L = 15\text{ pF}$ | 80* | 130* | | 70* | | 70 | | MHz |
| | | | $C_L = 50\text{ pF}$ | 55 | 85 | | 50 | | 50 | | |
| t_{PLH} | CLK | Q | $C_L = 15\text{ pF}$ | | 9* | 15* | 1* | 17* | 1 | 17 | ns |
| t_{PHL} | | | | | 9* | 15* | 1* | 17* | 1 | 17 | |
| t_{PZH} | \overline{OE} | Q | $C_L = 15\text{ pF}$ | | 8* | 13* | 1* | 15* | 1 | 15 | ns |
| t_{PZL} | | | | | 8* | 13* | 1* | 15* | 1 | 15 | |
| t_{PHZ} | \overline{OE} | Q | $C_L = 15\text{ pF}$ | | 9* | 14* | 1* | 16* | 1 | 16 | ns |
| t_{PLZ} | | | | | 10* | 14* | 1* | 16* | 1 | 16 | |
| t_{PLH} | CLK | Q | $C_L = 50\text{ pF}$ | | 10.6 | 16.2 | 1 | 18.5 | 1 | 18.5 | ns |
| t_{PHL} | | | | | 10.6 | 16.2 | 1 | 18.5 | 1 | 18.5 | |
| t_{PZH} | \overline{OE} | Q | $C_L = 50\text{ pF}$ | | 9.6 | 14.9 | 1 | 16 | 1 | 16 | ns |
| t_{PZL} | | | | | 9.6 | 14.9 | 1 | 16 | 1 | 16 | |
| t_{PHZ} | \overline{OE} | Q | $C_L = 50\text{ pF}$ | | 10.2 | 15.5 | 1 | 17 | 1 | 17 | ns |
| t_{PLZ} | | | | | 11.8 | 15.5 | 1 | 17 | 1 | 17 | |
| $t_{sk(o)}$ | | | $C_L = 50\text{ pF}$ | | | 1.5** | | | | 1.5 | ns |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $T_A = 25^\circ\text{C}$ | | | SN54AHC16374 | | SN74AHC16374 | | UNIT |
|-------------|-----------------|----------------|----------------------|--------------------------|------|------|--------------|-------|--------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f_{\max} | | | $C_L = 15\text{ pF}$ | 130* | 185* | | 110* | | 110 | | MHz |
| | | | $C_L = 50\text{ pF}$ | 85 | 120 | | 75 | | 75 | | |
| t_{PLH} | CLK | Q | $C_L = 15\text{ pF}$ | | 5.4* | 9.1* | 1* | 10.1* | 1 | 10.1 | ns |
| t_{PHL} | | | | | 5.4* | 9.1* | 1* | 10.1* | 1 | 10.1 | |
| t_{PZH} | \overline{OE} | Q | $C_L = 15\text{ pF}$ | | 5.1* | 9.1* | 1* | 10.1* | 1 | 10.1 | ns |
| t_{PZL} | | | | | 5.1* | 9.1* | 1* | 10.1* | 1 | 10.1 | |
| t_{PHZ} | \overline{OE} | Q | $C_L = 15\text{ pF}$ | | 5* | 9.5* | 1* | 10.5* | 1 | 10.5 | ns |
| t_{PLZ} | | | | | 5* | 9.5* | 1* | 10.5* | 1 | 10.5 | |
| t_{PLH} | CLK | Q | $C_L = 50\text{ pF}$ | | 6.9 | 10.1 | 1 | 11.5 | 1 | 11.5 | ns |
| t_{PHL} | | | | | 6.9 | 10.1 | 1 | 11.5 | 1 | 11.5 | |
| t_{PZH} | \overline{OE} | Q | $C_L = 50\text{ pF}$ | | 6.6 | 10.1 | 1 | 11.5 | 1 | 11.5 | ns |
| t_{PZL} | | | | | 6.6 | 10.1 | 1 | 11.5 | 1 | 11.5 | |
| t_{PHZ} | \overline{OE} | Q | $C_L = 50\text{ pF}$ | | 6.1 | 10.5 | 1 | 11.5 | 1 | 11.5 | ns |
| t_{PLZ} | | | | | 6.1 | 10.5 | 1 | 11.5 | 1 | 11.5 | |
| $t_{sk(o)}$ | | | $C_L = 50\text{ pF}$ | | | 1** | | | | 1 | ns |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

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SN54AHC16374, SN74AHC16374

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

SCLS330G – MARCH 1996 – REVISED JANUARY 2000

noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

| PARAMETER | SN74AHC16374 | | | UNIT |
|--|--------------|-------|------|------|
| | MIN | TYP | MAX | |
| $V_{OL(P)}$ Quiet output, maximum dynamic V_{OL} | | 0.36 | 0.8 | V |
| $V_{OL(V)}$ Quiet output, minimum dynamic V_{OL} | | –0.16 | –0.8 | V |
| $V_{OH(V)}$ Quiet output, minimum dynamic V_{OH} | | 4.6 | | V |
| $V_{IH(D)}$ High-level dynamic input voltage | 3.5 | | | V |
| $V_{IL(D)}$ Low-level dynamic input voltage | | | 1.5 | V |

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|--|-----------------------------|-----|------|
| C_{pd} Power dissipation capacitance | No load, $f = 1\text{ MHz}$ | 32 | pF |



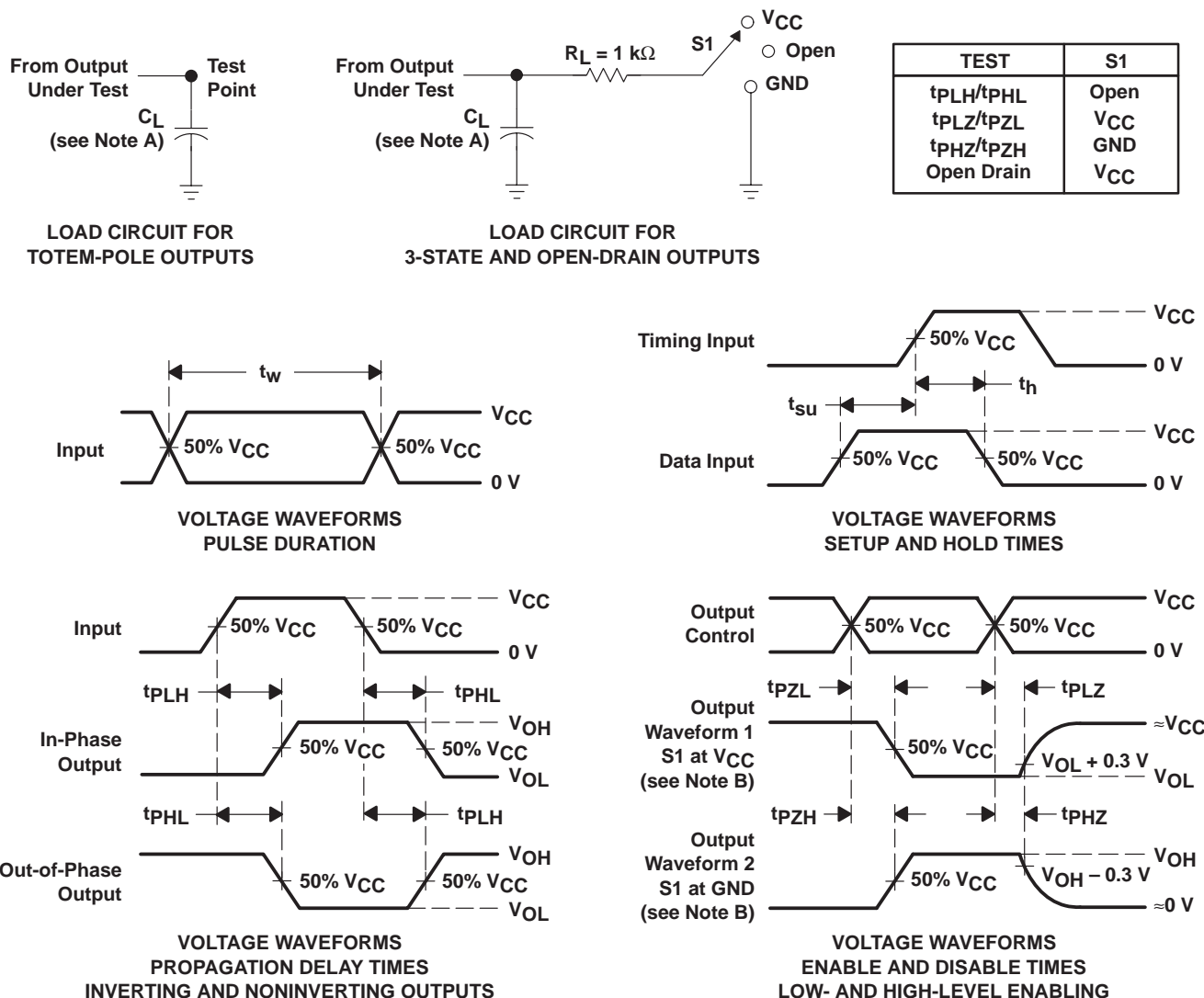
SN54AHC16374, SN74AHC16374

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74AHC16374DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AHC16374 | Samples |
| SN74AHC16374DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HE374 | Samples |
| SN74AHC16374DL | ACTIVE | SSOP | DL | 48 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AHC16374 | Samples |
| SN74AHC16374DLG4 | ACTIVE | SSOP | DL | 48 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AHC16374 | Samples |
| SN74AHC16374DLR | ACTIVE | SSOP | DL | 48 | 1000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AHC16374 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHC16374DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AHC16374DGVR | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |
| SN74AHC16374DLR | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHC16374DGGR | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74AHC16374DGVR | TVSOP | DGV | 48 | 2000 | 853.0 | 449.0 | 35.0 |
| SN74AHC16374DLR | SSOP | DL | 48 | 1000 | 367.0 | 367.0 | 55.0 |

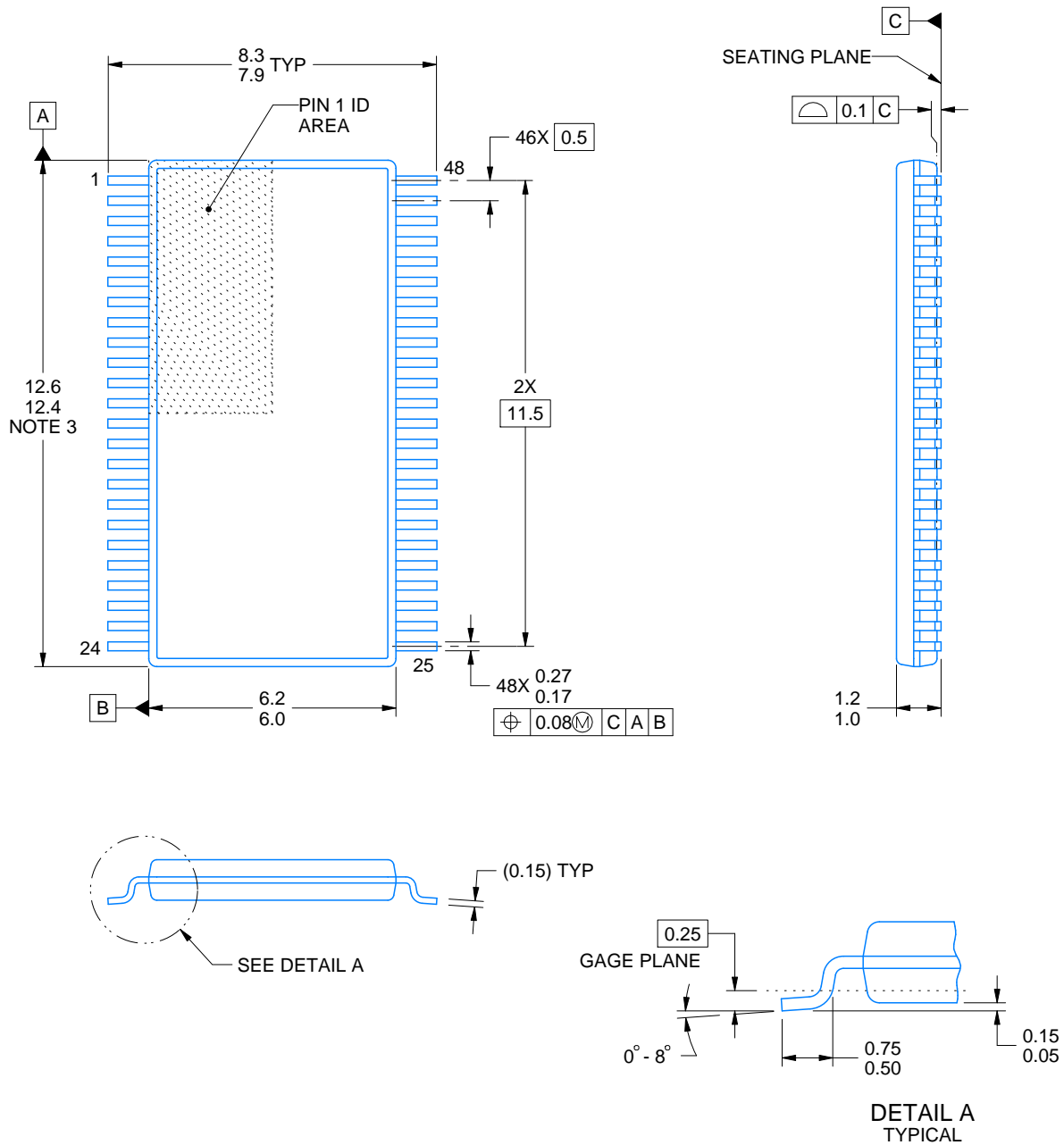
DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194



4214859/B 11/2020

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

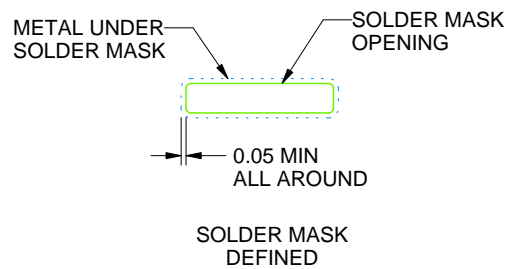
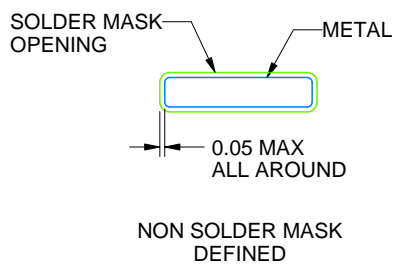
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

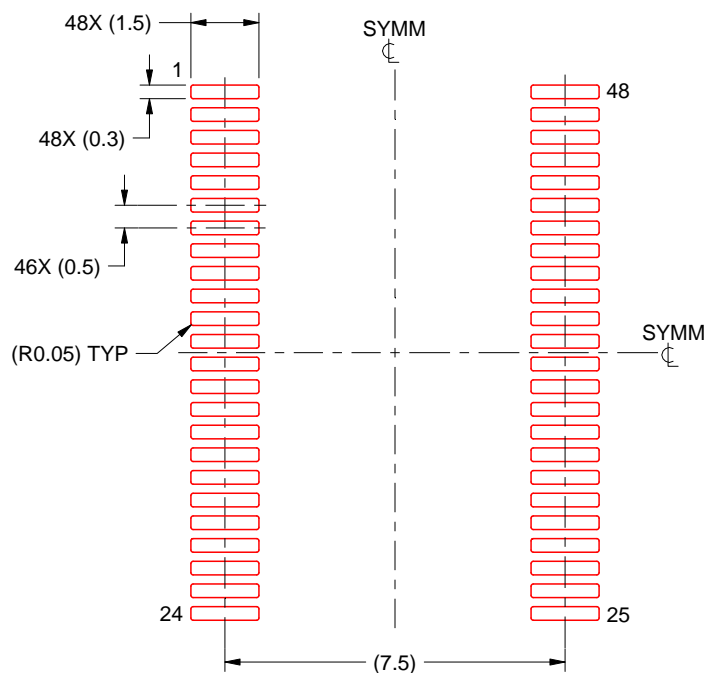
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

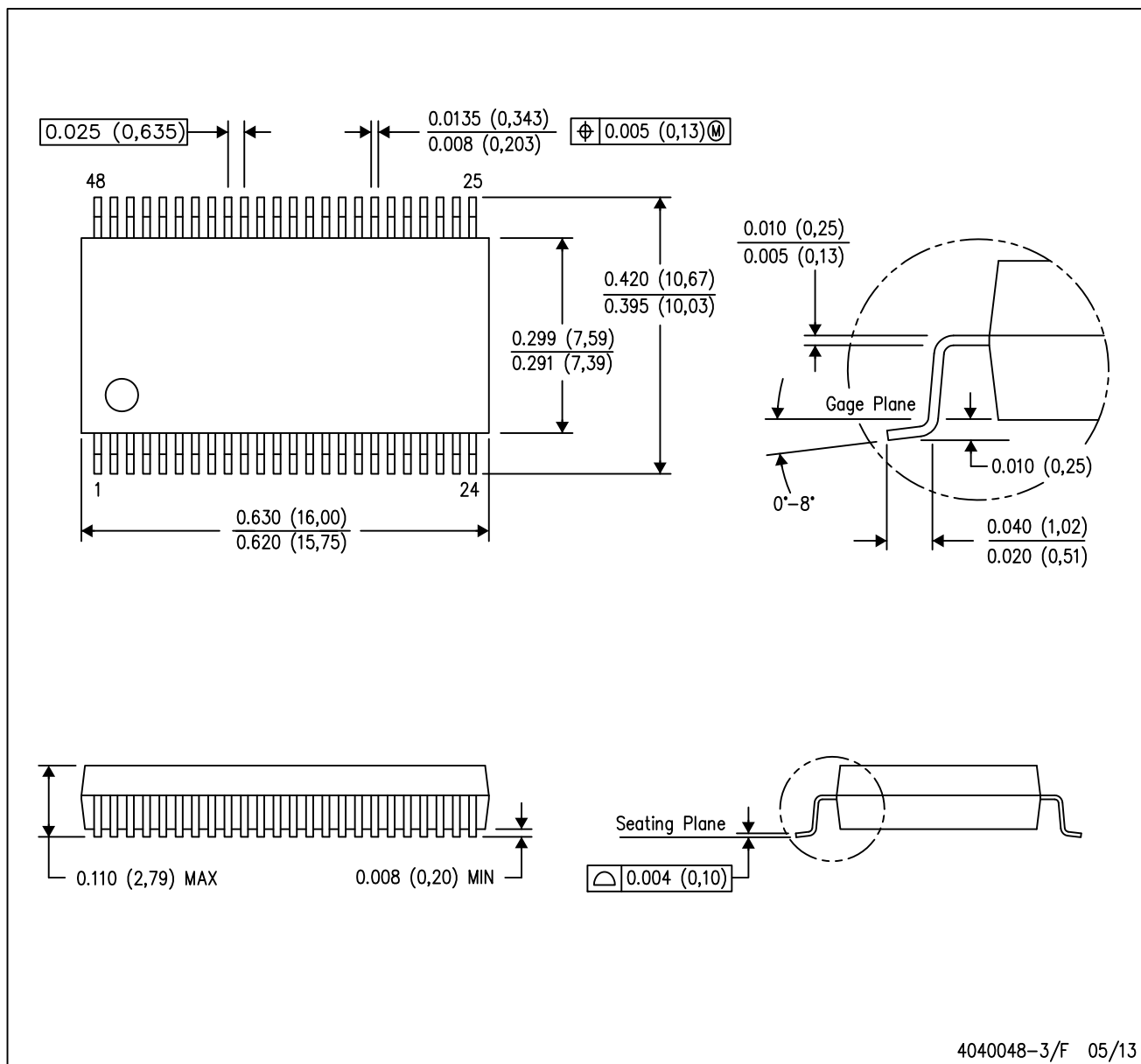
48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MO-118

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